



# Product Change Notification

**Change Notification #:** 115561 - 00  
**Change Title:** Intel® Wireless Gigabit Antenna-M 10101R,  
Intel® Wireless Gigabit Antenna-M M100041,  
Intel® Wireless Gigabit Antenna-M M100042 SKUs: FR10101RRFW;  
FR10042R.RFWG; 10041R.RFWG  
PCN 115561-00, Transport Media,  
Packaging Change for Standardization  
**Date of Publication:** June 07, 2017

## Key Characteristics of the Change:

Transport Media


## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Jun 23, 2017
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## Description of Change to the Customer:

Intel is streamlining the packaging for its Intel® Gigabit Wireless Antenna-M 10041R, Intel® Wireless Gigabit Antenna-M 10042R, and Intel® Wireless Gigabit Antenna-M 10101R Products.

- Intel is eliminating the need for polypropylene banding by replacing the current cardboard shim cover with a new thicker structural shim as seen in the before and after photos below. This will result in less waste and remove a handling step for the customer in receiving the product

Current	New
Process: Strap the polypropylene strapping band before put the shim cover on top of the tray. 	Process: Remove the polypropylene strapping band step before put the shim cover on top of the tray. 
IPN: 500046513- Thin Shim 	IPN: 500046512- Thick Shim 

## Customer Impact of Change and Recommended Action:

The indirect material and packing process change does not affect the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Marketing Name	Stepping	Product Code	S-Spec	MM#
Intel® Wireless Gigabit Antenna-M M10004	C1	FR10041R.RFWG	S R1UQ	933733
Intel® Wireless Gigabit Antenna-M M10004	C1	FR10042R.RFWG	S R2GK	944554
Intel® Wireless Gigabit Antenna-M 10101R	B2	FR10101RRFW	S R3AP	955536

## PCN Revision History:

**Date of Revision:**

June 7, 2017

**Revision Number:**

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**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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